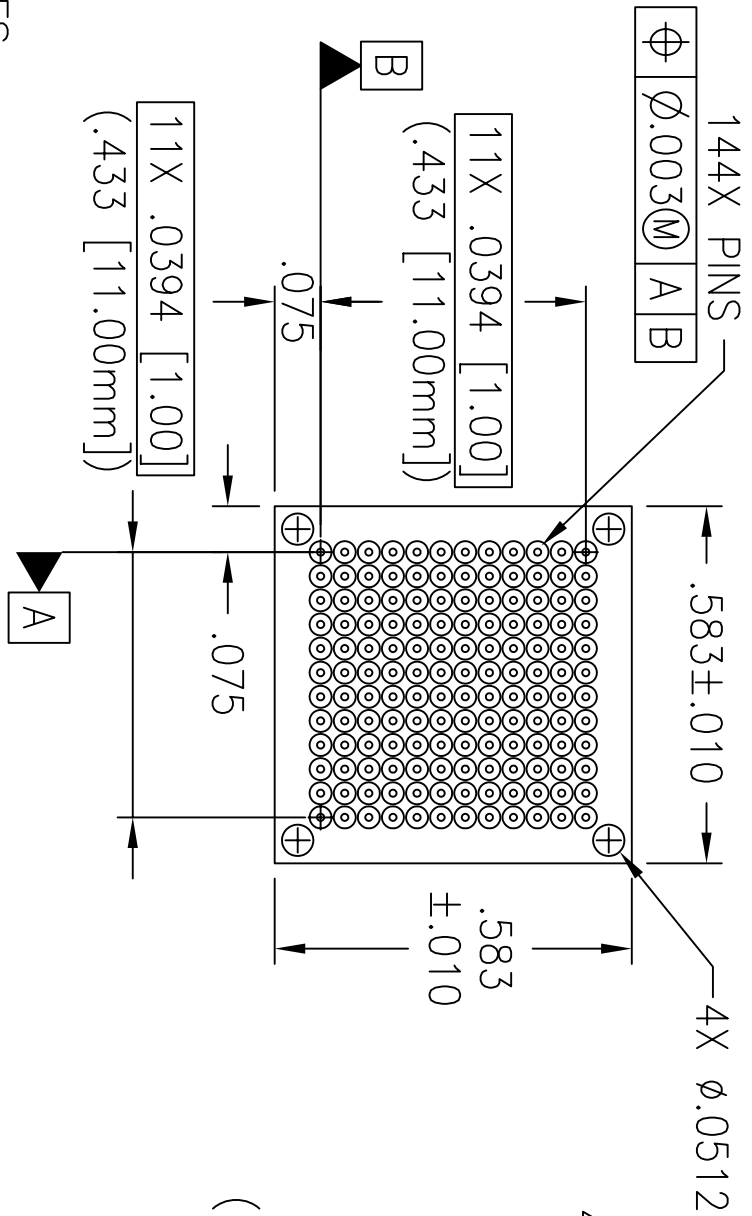
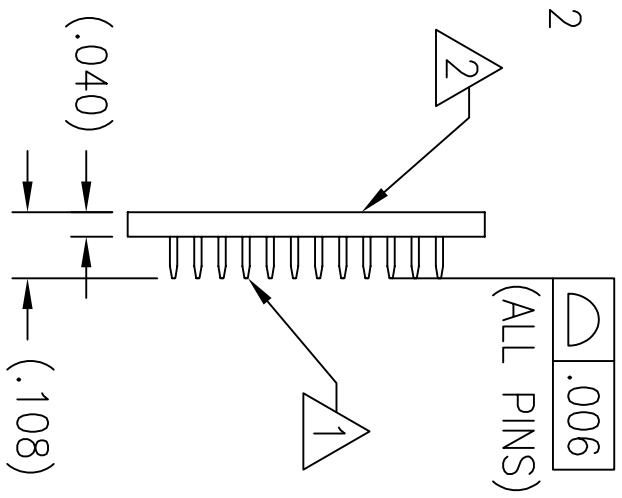


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TOP VIEW



RS VIEW



NOTES:

- 1. PINS Ø.0117  
MATERIAL: PHOSPHOR BRONZE.  
PLATING: HARD GOLD OVER NICKEL.
- 2. INSULATOR MATERIAL: FR4.

REV	DESCRIPTION	ECN	DATE	RELEASE
1	SALES RELEASE			

CONTRACT NO.		TITLE	
DRAWN BY	DATE	HIL0-BGA PIN BASE	
DESIGNER	DATE	12 X 12, 144 PINS	
CHECKER	DATE	1mm PITCH	
QA	DATE	SCALE	DRAWING NO.
PROCESS ENG.	DATE	N/A	HLP-120144-B-10
UNLESS OTHERWISE SPECIFIED: DIMENSIONS ARE IN INCHES TOLERANCES: ANGLES: ± 1/64 FINISHES: 31/64 DECIMALS: .XXX ±.005 .XXXX ±.0005		SAWED AS: HLP-120144-B-10.DWG	
DRAWING NO.		FINISHED ASST: HLP-120144-B-10	
DATE		SHEET 1 OF 1	

INTERCONNECT SYSTEMS INC.  
708 VIA ALONDRA, CAMARILLO, CA 93012

ASIZE 4 3 2 1